

March 2008

MM74HCT74 Dual D-Type Flip-Flop with Preset and Clear

Features

- Typical propagation delay: 20ns
- Low quiescent current: 40µA maximum (74HCT Series)
- Low input current: 1µA maximum
- Fanout of 10 LS-TTL loads
- Meta-stable hardened

General Description

The MM74HCT74 utilizes advanced silicon-gate CMOS technology to achieve operation speeds similar to the equivalent LS-TTL part. It possesses the high noise immunity and low power consumption of standard CMOS integrated circuits, along with the ability to drive 10 LS-TTL loads.

This flip-flop has independent data, preset, clear, and clock inputs and Q and \overline{Q} outputs. The logic level present at the data input is transferred to the output during the positive-going transition of the clock pulse. Preset and clear are independent of the clock and accomplished by a low level at the appropriate input.

The 74HCT logic family is functionally and pin-out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

MM74HCT devices are intended to interface between TTL and NMOS components and standard CMOS devices. These parts are also plug-in replacements for LS-TTL devices and can be used to reduce power consumption in existing designs.

Ordering Information

Order Number	Package Number	Package Description
MM74HCT74M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
MM74HCT74SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HCT74MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HCT74N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.

Outputs

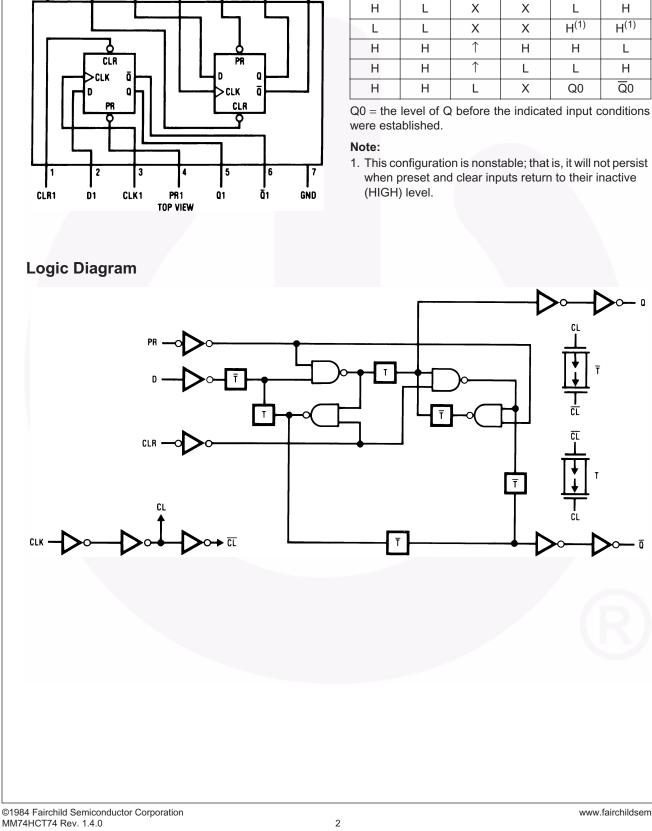
Q

Н

Q

L

۵



Truth Table

PR

L

Inputs

CLK

Х

D

Х

CLR

Н

Connection Diagram

D2

CLR2

13

Vcc

14

Pin Assignments for DIP, SOIC, SOP and TSSOP

CLK2

PR2

10

Q2

Ō2

Absolute Maximum Ratings⁽²⁾

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	-0.5 to +7.0V
V _{IN}	DC Input Voltage	–1.5 to V _{CC} +1.5V
V _{OUT}	DC Output Voltage	–0.5 to V _{CC} +0.5V
I _{IK} , I _{OK}	Clamp Diode Current	±20mA
I _{OUT}	DC Output Current, per pin	±25mA
I _{CC}	DC V _{CC} or GND Current, per pin	±50mA
T _{STG}	Storage Temperature Range	–65°C to +150°C
P _D	Power Dissipation Note 3 S.O. Package only	600mW 500mW
ΤL	Lead Temperature (Soldering 10 seconds)	260°C

Notes:

2. Unless otherwise specified all voltages are referenced to ground.

3. Power Dissipation temperature derating - plastic "N" package: -12 mW/°C from 65°C to 85°C.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Units
V _{CC}	Supply Voltage	4.5	5.5	V
V _{IN} , V _{OUT}	DC Input or Output Voltage	0	V _{CC}	V
T _A	Operating Temperature Range	-40	+85	°C
t _r , t _f	Input Rise or Fall Times		500	ns

DC Electrical Characteristics

 $V_{CC}\,{=}\,5V\,{\pm}10\%$ (unless otherwise specified).

			T _A =				
				25°C	–40°C to 85°C	–55°C to 125°C	•
Symbol	Parameter	Conditions	Typ. Guaranteed Limits			mits	Units
V _{IH}	Minimum HIGH Level Input Voltage			2.0	2.0	2.0	V
V _{IL}	Maximum LOW Level Input Voltage			0.8	0.8	0.8	V
V _{OH}	Minimum HIGH Level	$V_{IN} = V_{IH} \text{ or } V_{IL}, I_{OUT} = 20 \mu A$	V _{CC}	V _{CC} – 0.1	V _{CC} - 0.1	V _{CC} – 0.1	V
Output Voltage	$V_{IN} = V_{IH} \text{ or } V_{IL}, I_{OUT} = 4.0 \text{mA},$ $V_{CC} = 4.5 \text{V}$	4.2	3.98	3.84	3.7		
		$V_{IN} = V_{IH} \text{ or } V_{IL}, I_{OUT} = 4.8 \text{mA},$ $V_{CC} = 5.5 \text{V}$	5.2	4.98	4.84	4.7	
V _{OL}	Maximum LOW Level	$V_{IN} = V_{IH} \text{ or } V_{IL}, I_{OUT} = 20 \mu A$	0	0.1	0.1	0.1	V
	Voltage	$V_{IN} = V_{IH} \text{ or } V_{IL}, I_{OUT} = 4.0 \text{mA},$ $V_{CC} = 4.5 \text{V}$	0.2	0.26	0.33	0.4	
		$V_{IN} = V_{IH} \text{ or } V_{IL}, I_{OUT} = 4.8 \text{mA},$ $V_{CC} = 5.5 \text{V}$	0.2	0.26	0.33	0.4	
I _{IN}	Maximum Input Current	$V_{IN} = V_{CC}$ or GND, V_{IH} or V_{IL}		±0.5	±0.5	±1.0	μA
I _{CC}	Maximum Quiescent	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0\mu A$		2.0	20	80	μA
	Supply Current	V _{IN} = 2.4V or 0.5V ⁽⁴⁾		0.3	0.4	0.5	mA

Note:

4. This is measured per pin. All other inputs are held at V_{CC} Ground.

AC Electrical Characteristics

 $V_{CC} = 5V$, $T_A = 25^{\circ}C$, $C_L = 15 \text{ pF}$, $t_r = t_f = 6\text{ns}$.

Symbol	Parameter	Conditions	Тур.	Guaranteed Limit	Units
f _{MAX}	Maximum Operating Frequency from Clock to Q or \overline{Q}		50	30	MHz
t _{PHL} , t _{PLH}	Maximum Propagation Delay Clock to Q or \overline{Q}		18	30	ns
t _{PHL} , t _{PLH}	Maximum Propagation Delay from Preset or Clear to Q or $\overline{\mathbf{Q}}$		18	30	ns
t _{REM}	Minimum Removal Time, Preset or Clear to Clock			20	ns
t _S	Minimum Setup Time Data to Clock			20	ns
t _H	Minimum Hold Time Clock to Data		-3	0	ns
t _W	Minimum Pulse Width Clock, Preset or Clear		8	16	ns

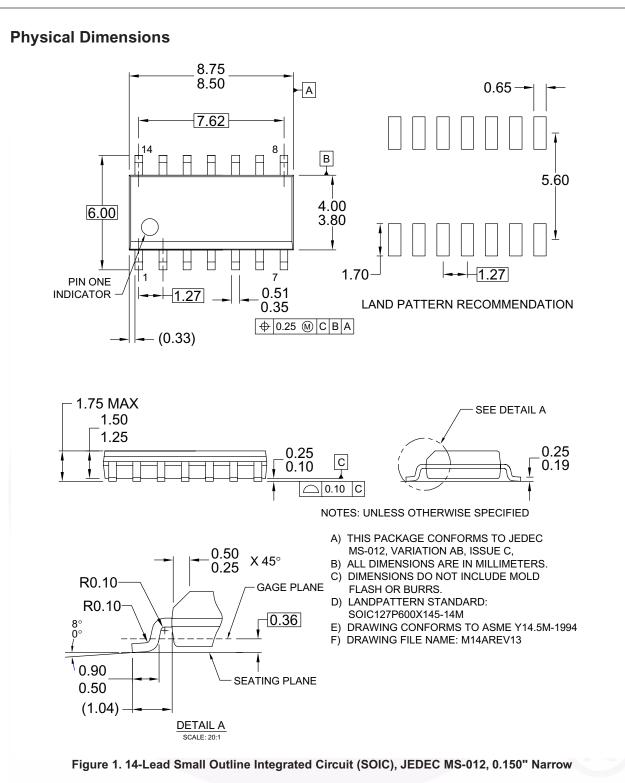
AC Electrical Characteristics

 $V_{CC}\,{=}\,5.0V$ \pm 10%, $C_L\,{=}\,50$ pF, $t_r\,{=}\,t_f\,{=}\,6ns$ unless otherwise specified.

			T _A =	= 25°C	$T_A = -40^{\circ} \text{ to } +85^{\circ}\text{C}$	
Symbol	Parameter	Conditions	Тур.	Gu	aranteed Limits	Units
f _{MAX}	Maximum Operating Frequency			27	21	MHz
t _{PHL} , t _{PLH}	Maximum Propagation Delay from Clock to Q or \overline{Q}		21	35	44	ns
t _{PHL} , t _{PLH}	Maximum Propagation Delay from Preset or Clear to Q or \overline{Q}		21	35	44	ns
t _{REM}	Minimum Removal Time Preset or Clear to Clock			20	25	ns
t _S	Minimum Setup Time Data to Clock			20	25	ns
t _H	Minimum Hold Time Clock to Data		-3	0	0	ns
t _W	Minimum Pulse Width Clock, Preset or Clear		9	16	20	ns
t _r , t _f	Maximum Clock Input Rise and Fall Time			500	500	ns
t _{THL} , t _{TLH}	Maximum Output Rise and Fall Time			15	19	ns
C _{PD}	Power Dissipation Capacitance ⁽⁵⁾	(per flip-flop)	10			pF
C _{IN}	Maximum Input Capacitance		5	10	10	pF

Note:

5. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

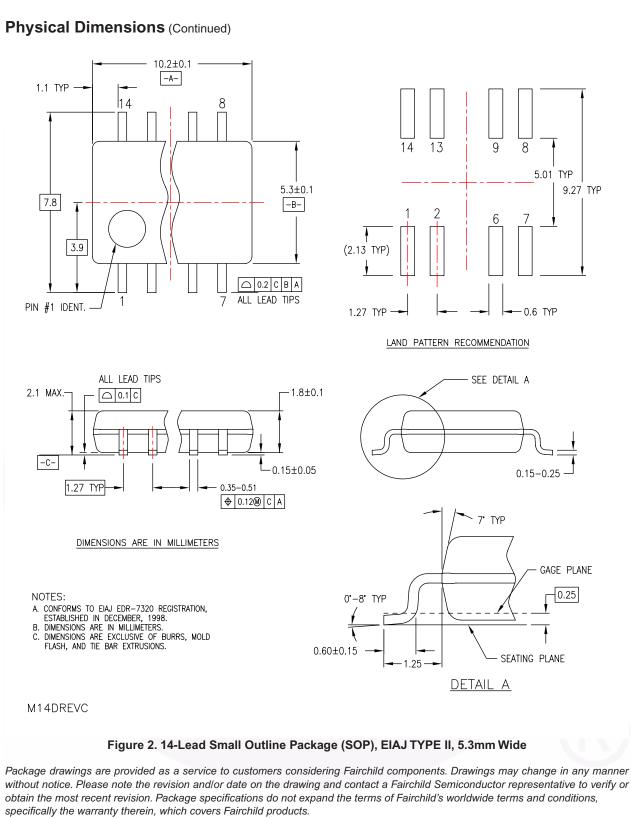


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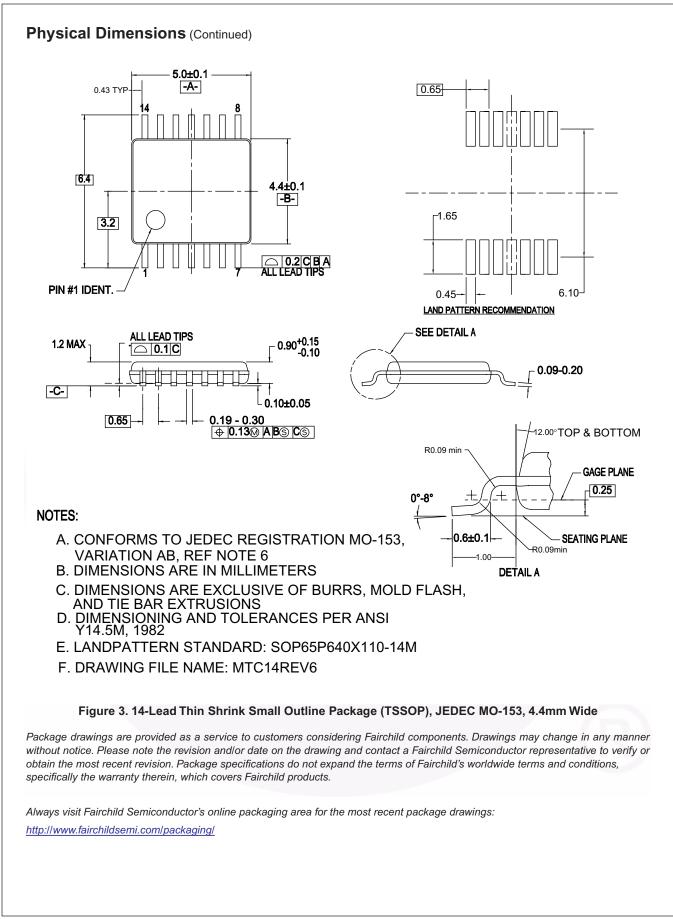
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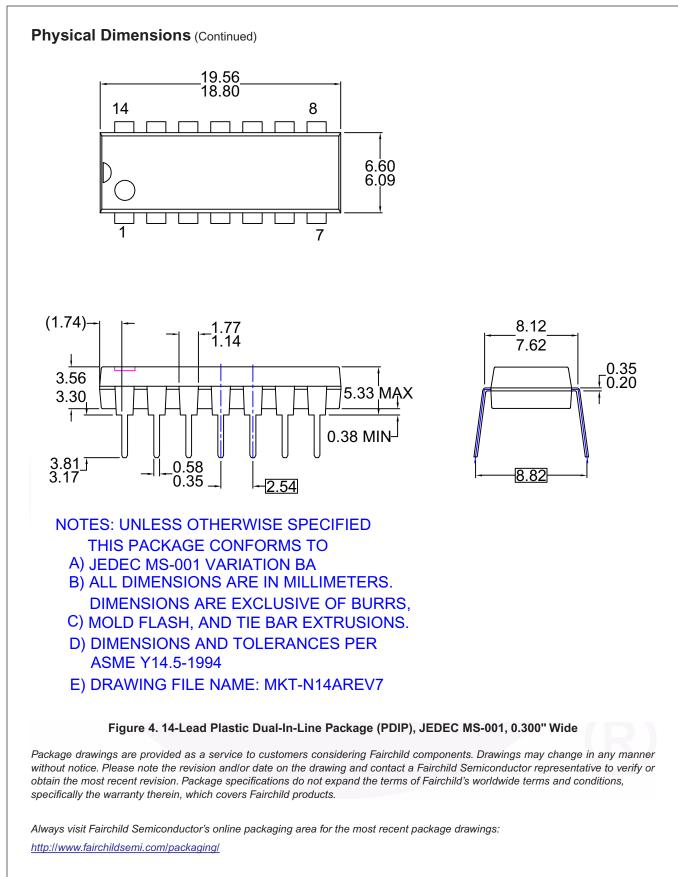
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